

To Be Discontinued

SN8000/8000UFL Data Sheet

Wi-Fi Module



Revision History

Revision	Date	Author	Change Description
1.0	11/08/13	R. Willett	Initial version
1.1	11/25/13	R Willett	Removed SyChip logo; revised copyright notice; revised tech support information; deleted Chap 12 "Disclaimer;" deleted one referenced document, 1.4 – Reference, page 6; revised Table 14, page 20;
2.0	7/29/14	R. Willett	Applied the new Murata V.I. throughout; added Anatel certification to Chapter 10, page 22.
2.1	8/22/14	R. Willett	Revised Table 14
2.2	7/28/15	R. Willett	Deleted minimum values for Receive Sensitivity on Table 9 page 16, Table 10 page 17, and Table 11 page 18.
2.3	5/06/16	R. Willett	Removed statement "RFM products are now Murata products;" updated copyright notice in bottom page margin; updated transmit out power spec for SN8000UFL in Tables 9, 10, 11.
2.4	09/21/16	R. Willett	Table 14 – changed VDD_IO Min to 1.71, deleted Typ, changed Max to 3.63; updated Copyright
2.5	05/08/17	R. Willett	Removed references to SPI Interface.
2.6	05/26/17	R. Willett	Table 4 – removed entries "Input high voltage (VDD_IO = 1.8V)" and "Input low voltage (VDD_IO = 1.8V)" Table 13 – changed VDD-IO Min to 2.40, add back typ 3.30, and changed Max to 3.60.

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1 System Descriptions

1.1 Applications

The SN8000 is a certified 2.4 GHz IEEE 802.11b/g/n Wi-Fi module based on the Broadcom BCM43362 chipset. It is designed to fit indoor and outdoor sensor and control applications. The SN8000 integrates a Wi-Fi IC, RF front end, temperature compensated crystal (TCXO) and an onboard antenna.

The SN8000 is compatible with Broadcom WICED™ SDK software to support low power, low cost microcontroller platforms from STM32 ARM Cortex M3 and M4 families.

The SN8000 module is an ideal solution for home automation, industrial control, Smart Energy, medical, and healthcare applications with or without cloud services.

A footprint compatible version with U.FL connector, SN8000UFL, is also available for use with an external antenna.

Module Summary

- 2.4GHz IEEE 802.11b/g/n radio technology
- Dimension: 24.0 mm x 11.4 mm x 2.0mm
- Antenna Configuration: On-board chip antenna or U.FL connector
- Transmit power: +18.5 dBm @ 802.11b
- Receive sensitivity: -96dBm
- Host interface: SDIO
- Operating temperature range: -40°C to 85°C
- RoHS2 compliant
- MSL Level 3
- FCC/IC certified; ETSI compliant
- Compatible with Broadcom WICED™ SDK

1.2 Block Diagram

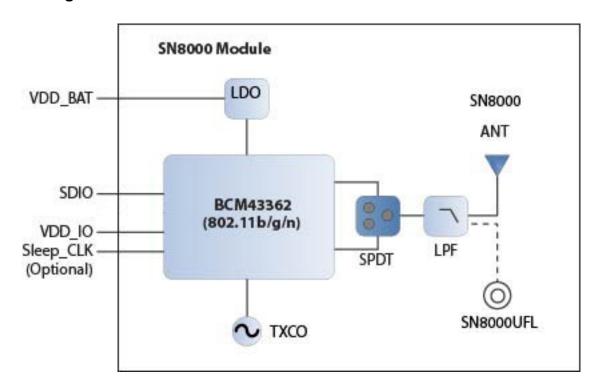


Figure 1 SN8000/8000UFL Module Block Diagram

1.3 Acronyms

ISM Industrial, Scientific and Medical

MAC Medium Access Control

MSL Moisture Sensitivity Level

PER Packet Error Rate

ROHS Restriction of Hazardous Substances

SDIO Secure Digital Input Output

1.4 Reference

[1] SN8000/SN8000UFL Wi-Fi Module User Manual, Murata

2 Mechanical Specifications

2.1 Module dimension (SN8000 / SN8000UFL)

Parameter	Typical	Units	
Dimension (LxWxH)	24.0 x 11.4 x 2.0	mm	
Dimension tolerances (LxWxH)	±0.2/±0.2/±0.15	mm	

2.2 Module top and side view

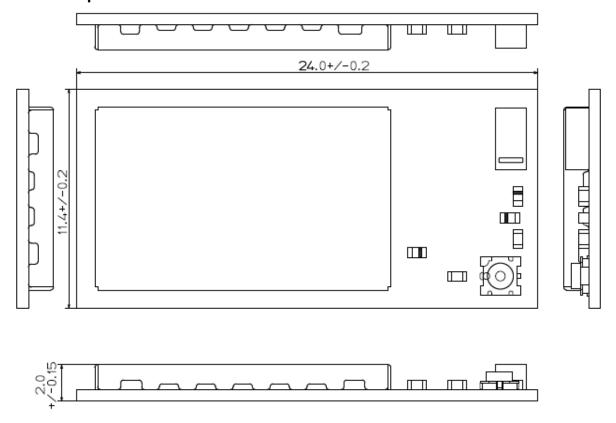


Figure 2 SN8000 Top and Side View

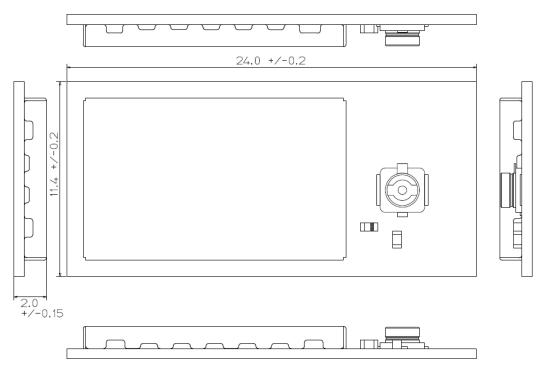


Figure 3 SN8000UFL Top and Side View

2.3 **PCB footprint (top view)**

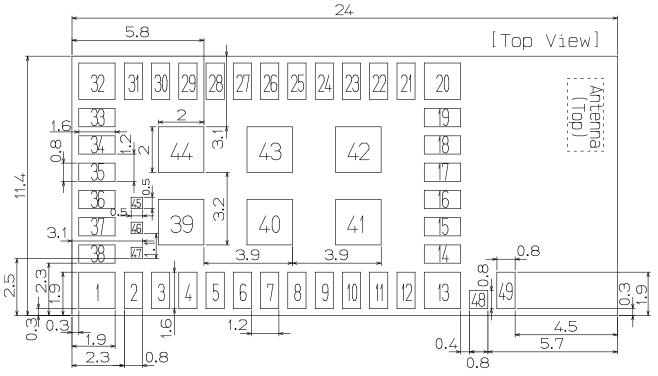


Figure 4 Detailed Pad Dimensions (For both SN8000 and SN8000UFL) (top view)

2.4 Module Pin-out

Table 1 Module Connector Signal Description

	Table 1 Module Connector Signal Description						
Pin #	Pin name	I/O	Description				
1	GND	-	Ground				
2	SDIO_D2	I/O	SDIO data line 2 with internal weak pull-up that can be disabled.				
3	JTAG_TDI	-	JTAG_TDI, N/C otherwise.				
4	JTAG_TDO	-	JTAG_TDO, N/C otherwise.				
5	BTCX_FREQ/GPIO1	I/O	GPIO/Coexistence output signal indicating Bluetooth transmission in restricted channel. Hi-Z at power-up and reset.				
6	GPIO0	I/O	GPIO/Strapping option for SDIO (pull low). Has weak internal pull down.				
7	ANT_SEL2	0	Auxiliary antenna selection (RFSW_CONTROL3). Default low.				
8	ANT_SEL1	0	Main antenna selection (RFSW_CONTROL0). Default high.				
9	GND	-	Ground				
10	RST_N	I	Active low WLAN reset signal with internal 200K pull-down.				
11	VDD_3V3_EN	I	Enables 3.3V LDO				
12	VDD_BAT	I	Module power supply				
13	GND	-	Ground				
14	GND	-	Ground				
15	GND	-	Ground				
16	GND	-	Ground				
17	GND	-	Ground				
18	GND	-	Ground				
19	GND	-	Ground				
20	GND	-	Ground				
21	GND	-	Ground				
22	GND	-	Ground				
23	GND	-	Ground				
24	GND	-	Ground				
25	GND	-	Ground				
26	GND	-	Ground				
27	GND	-	Ground				
28	BTCX_STATUS/GPIO4	I/O	GPIO/Coexistence signal indicating Bluetooth priority status and TX/RX direction. Hi-Z at power-up and reset.				

D' //	P'	1/0	December 2
Pin #	Pin name	I/O	Description
29	BTCX_TXCONF/GPIO3	I/O	GPIO/Coexistence output giving Bluetooth permission to transmit. Hi-Z at power-up and reset.
30	BTCX_RF_ACTIVE/GPIO5	I/O	GPIO/Coexistence signal indicating Bluetooth is active. Hi-Z at power-up and reset.
31	SLEEP_CLK	I	Optional external 32KHz sleep clock. Tie to GND if not used.
32	GND	-	Ground
33	VDD_IO	I	Power for IO and SDIO pads
34	SDIO_D1 _IRQ	I/O	SDIO data line 1 with internal weak pull-up that can be disabled.
35	SDIO_D0 _MISO	I/O	SDIO data line 0 with internal weak pull-up that can be disabled.
36	SDIO_CLK _CLK	I	SDIO clock.
37	SDIO_CMD _MOSI	I/O	SDIO command line with internal weak pull-up that can be disabled.
38	SDIO_D3 _CSX	I/O	SDIO data line 3 with internal weak pull-up that can be disabled.
39	GND	-	Ground
40	GND	-	Ground
41	GND	-	Ground
42	GND	-	Ground
43	GND	-	Ground
44	GND	-	Ground
45	JTAG_TCK	-	JTAG_TCK, N/C otherwise.
46	JTAG_TRSTN	-	JTAG_TRSTN, N/C otherwise.
47	JTAG_TMS	-	JTAG_TMS, N/C otherwise.
48	NC4	-	No connect
49	GND	-	Ground

3 DC Electrical Specifications

3.1 **Typical Power Consumption**

Condition: 25°C, VDD_BAT=3.6V, VDD_IO= 3.6V

Table 2 Typical Power Consumption for SN8000

Item		Condition		Units		
		Condition	Min	Тур	Max	
	Receive mode			70		mA
11b	Transmit mode (18.5dBm/100% Duty Cycle)	11Mbps		315		mA
	Receive mode	C 4N Mara a		70		mA
11g	Transmit mode (14.5dBm/100 % Duty Cycle)	54Mbps		235		mA
	Receive mode	MCS7		70		mA
11n	Transmit mode (13.5dBm/100% Duty Cycle)	IVIC57		225		mA

Table 3 Typical Power Consumption for SN8000UFL

Item		Condition		Units		
		Condition	Min	Тур	Max	
	Receive mode			70		mA
11b	Transmit mode (16.5dBm/100% Duty Cycle)	11Mbps		285		mA
	Receive mode	F 4Mbp o		70		mA
11g	Transmit mode (14.5dBm/ 100 % Duty Cycle)	54Mbps		235		mA
	Receive mode	MCS7		70		mA
11n	Transmit mode (13.5dBm/100% Duty Cycle)	IVICS7		225		mA

3.2 Power Up/Down Sequence

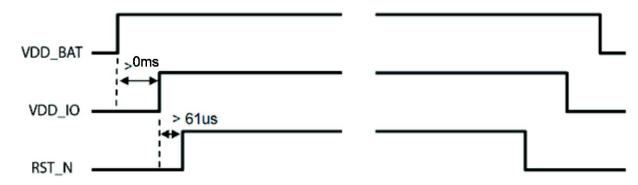


Figure 5 Boot-Up Sequence

3.3 **GPIO Interface**

Five general purpose I/O (GPIO) pins are available on the SN8000 that can be used to connect to various external devices.

GPIOs are tristated by default. Subsequently, they can be programmed to be either input or output pins via the GPIO control register. They can also be programmed to have internal pull-up or pull-down resistors.

GPIO_0 is initially used as a strapping option to select SDIO mode (pull low).

GPIOs 3, 4, and 5 are multiplexed with the Bluetooth Coexistence Interface. By default, these pins are BT_COEX pins. Software can reprogram these pins to behave as GPIOs.

GPIO 1 is a GPIO by default, but can be programmed to become the BCTX FREQ signal.

	SYM	min.	typ.	max.	unit
Input low voltage (VDD_IO = 3.3V)	VIL	-	-	0.8	V
Input high voltage (VDD_IO = 3.3V)	VIH	2.0	-	VDD_IO	V
Input low voltage (RESET pin)	V _{IL}	-	-	0.4	V
Input high voltage (RESET pin)	VIH	1.08	-	3.6	V
Output low voltage	VOL	-	-	0.4	V
Output high voltage	VOH	VDD_IO-0.4	-	-	V
Input low current	ΙĮL	-	0.3	-	uA
Input high current	lін	-	0.3	-	uA

Table 4 Digital I/O Requirements

3.4 SDIO Interface

Table 5 SDIO Pin Description

No.	Pin Name	(i) SD 4-bit Mode		(ii) S	D 1-bit Mode
2	SDIO_D2	DATA2	Data line 2	NC	Not used
34	SDIO_D1	DATA1	Data line 1 /Interrupt	IRQ	Interrupt
35	SDIO_D0	DATA0	Data line 0	DATA	Data line
36	SDIO_CLK	CLK	Clock	CLK	Clock
37	SDIO_CMD	CMD	Command line	CMD	Command line
38	SDIO_D3	DATA3	Data line 3	NC	Not used

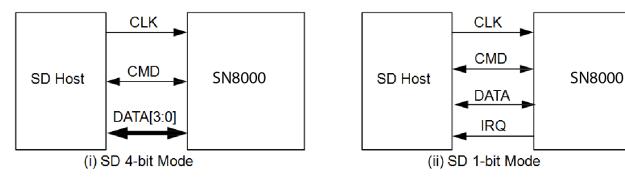


Figure 6 SDIO Connection

3.4.1 SDIO Timing (Default Mode)

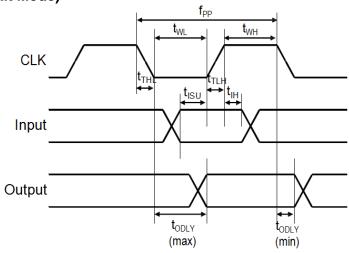


Figure 7 SDIO Timing (Defualt Mode)

Table 6 SDIO Interface Timing Default

Parameter	Symbol	Min ⁽¹⁾	Typ ⁽¹⁾	Max ⁽¹⁾	Unit	
Clock CLK (All values are referred to min. VIH and max.	VIL ⁽²⁾					
Frequency-Data Transfer Mode	fPP	0	-	25	MHz	
Frequency-Identification Mode	fOD	0	-	400	kHz	
Clock Low Time	tWL	10	-	-	ns	
Clock High Time	tWH	10	-	-	ns	
Clock Rise Time	tTLH	-	-	10	ns	
Clock Falling Time	tTHL	-	-	10	ns	
Inputs: CMD, DAT (referenced to CLK)						
Input Setup Time	tISU	5	-	-	ns	
Input Hold Time	tlH	5	-	-	ns	
Outputs: CMD, DAT (referenced to CLK)						
Output Delay time-Data Transfer Mode	tODLY	0	-	14	ns	
Output Delay time-Identification Mode	tODLY	0	-	50	ns	

 ^{(1).} Timing is based on CL ≤ 40pF load on CMD and Data.
 (2). Min (Vih) = 0.7*VDDIO and max (Vil) = 0.2*VDDIO.

3.4.2 SDIO Timing (High Speed Mode)

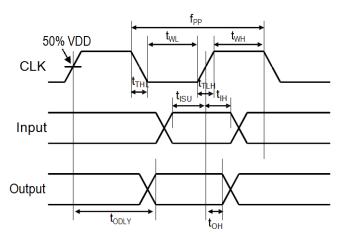


Figure 8 SDIO Timing (High Speed Mode)

Table 7 SDIO Timing - High Speed

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Parameter	Symbol	Min ⁽¹⁾	Typ (1)	Max ⁽¹⁾	Unit
Clock CLK (All values are referred to min. VIH and max.	VIL ⁽²⁾				
Frequency-Data Transfer Mode	fPP	0	-	50	MHz
Frequency-Identification Mode	fOD	0	-	400	kHz
Clock Low Time	tWL	7	-	-	ns
Clock High Time	tWH	7	-	-	ns
Clock Rise Time	tTLH	-	-	3	ns
Clock Falling Time	tTHL	-	-	3	ns
Inputs: CMD, DAT (referenced to CLK)					
Input Setup Time	tISU	6	-	-	ns
Input Hold Time	tlH	2	-	-	ns
Outputs: CMD, DAT (referenced to CLK)					
Output Delay time-Data Transfer Mode	tODLY	-	-	14	ns
Output Hold time	tOH	2.5	-	-	ns
Total System Capacitance (each line)	CL	-	-	40	pF

^{(1).} Timing is based on $CL \le 40 pF$ load on CMD and Data. (2). Min (Vih) = $0.7*VDD_IO$ and max (Vil) = $0.2*VDD_IO$.

4 RF Specifications

4.1 DC/RF Characteristics for IEEE 802.11b

Conditions: 25deg.C, VDD_BAT=3.6V, VDD_IO= 3.3V (11Mbps mode unless otherwise specified.)
Parameters measured at RF connector except EIRP

Table 8 RF Characteristics for IEEE 802.11b

Parameters		Specification				
Modulation		DSSS/CCK				
Physical layer data rate RF Characteristics		1,2,5.5,11Mbps				
		Min	Тур.	Max.	Unit	
Frequency range		2400		2483.5	MHz	
Carrier frequency error		-20		+20	ppm	
Transmit output power 1	SN8000UFL	15.0	17.0	20.0	dBm	
Transmit power, EIRP	SN8000		18.5		dBm	
Spectrum mask						
1 st side lobes				-30	dBr	
2 nd side lobes				-50	dBr	
Power-on and Power-down ramp				2	usec	
RF Carrier Suppression		15			dBc	
Modulation accuracy (EVM)				35	%	
Outband spurious emissions						
30MHz to 1GHz (BW=100KHz)				-96	dBm	
1GHz to 12.75GHz (BW=1MHz)				-41	dBm	
1.8GHz to 1.9GHz (BW=1MHz)				-65	dBm	
5.15GHz to5.3GHz (BW=1MHz)				-85	dBm	
Receive Sensitivity ¹						
1Mbps (FER≤ 8%)			-96		dBm	
11Mbps (FER≤ 8%)			-88		dBm	
Maximum input level (FER≤ 8%)		-9.5			dBm	
Adjacent channel rejection (FER≤ 8%)		35			dB	

[Note]

1. Derate by 1.5 dB for temperatures less than -10 °C or more than +55 °C in both transmit and receive modes.

4.2 DC/RF Characteristics for IEEE 802.11g

Condition: 25deg.C, VDD_BAT=3.6V, VDD_IO= 3.3V (54Mbps mode unless otherwise specified.)

Parameters measured at RF connector except EIRP

Table 9 RF Characteristics for IEEE 802.11g

Parameters		Specification				
Standard conformance		IEEE 802.11 g				
Modulation Data rate		OFDM 6, 9, 12, 18, 24, 36, 48, 54Mbps				
Frequency range		2400		2483.5	MHz	
Carrier frequency error		-20		+20	ppm	
Transmit output power 1	SN8000UFL	12.5	14.5	17.5	dBm	
Transmit power, EIRP	SN8000		14.5		dBm	
Spectrum mask				L	L	
9MHz to 11MHz (0dB ~ -20dB)		0		-	dB	
11MHz to 20MHz (-20dB ~ -28dB)		0		-	dB	
20MHz to 30MHz (-28dB ~ -40dB)		0		-	dB	
30MHz to 33MHz (-40dB)		0		-	dB	
Constellation Error (EVM)				-25	dB	
Outband spurious emissions				I	L	
30MHz to 1GHz (BW=100KHz)				-96	dBm	
1GHz to 12.75GHz (BW=1MHz)				-41	dBm	
1.8GHz to 1.9GHz (BW=1MHz)				-65	dBm	
5.15GHz to5.3GHz (BW=1MHz)				-85	dBm	
Receive Sensitivity ¹						
6Mbps (PER≤ 10%)			-89		dBm	
54Mbps (PER ≤ 10%)			-74		dBm	
Maximum input level (PER ≤ 10%)		-13			dBm	
Adjacent channel rejection (PER ≤ 10%)		-1			dB	

[Note]

1. Derate by 1.5 dB for temperatures less than -10 °C or more than +55 °C in both transmit and receive modes.

4.3 DC/RF Characteristics for IEEE 802.11n

Condition: 25deg.C, VDD_BAT=3.6V, VDD_IO= 3.3V (65Mbps mode unless otherwise specified.)

Parameters measured at RF connector except EIRP

Table 10 RF Characteristics for IEEE 802.11n

Parameters		Specification				
Standard conformance		IEEE 802.11 n				
Modulation		OFDM				
Data rate		6.5, 13, 19.5, 26, 39, 52, 58.5, 65Mbps				
RF Characteristics		Min	Тур.	Max.	Unit	
Frequency range		2400		2483.5	MHz	
Carrier frequency error		-20		+20	ppm	
Transmit output power 1	SN8000UFL	11.5	13.5	16.5	dBm	
Transmit power, EIRP	SN8000		13.5		dBm	
Spectrum mask						
9MHz to 11MHz (0dB ~ -20dB)		0		-	dB	
11MHz to 20MHz (-20dB ~ -28dB)		0		-	dB	
20MHz to 30MHz (-28dB ~ -45dB)		0		-	dB	
30MHz to 33MHz (-45dB)		0		-	dB	
Constellation Error (EVM)				-28	dB	
Outband spurious emissions						
30MHz to 1GHz (BW=100KHz)				-96	dBm	
1GHz to 12.75GHz (BW=1MHz)				-41	dBm	
1.8GHz to 1.9GHz (BW=1MHz)				-65	dBm	
5.15GHz to5.3GHz (BW=1MHz)				-85	dBm	
Receive Sensitivity ¹			1	<u> </u>	L	
65Mbps (PER ≤ 10%)			-71		dBm	
Maximum input level (PER ≤ 10%)		-13			dBm	
Adjacent channel rejection (PER ≤ 10%)		-2			dB	

[Note]

1. Derate by 1.5 dB for temperatures less than -10 °C or more than +55 °C in both transmit and receive modes.

5 Antenna Information

The table below shows the information of the reference antennae that are used in FCC, IC and ETSI testing for SN8000UFL.

Table 11 External Antenna to comply with regulation (Only SN8000UFL)

Part Number	Vendor	Gain (dBi)	Antenna Type	Connector	Remarks
TRF-1002	Microchip	5.0	Omnidirectional	U.FL	For FCC/IC compliance
W1049B050	Pulse	2.0	Omnidirectional	U.FL	For FCC/IC and ETSI compliance
W3525B100	Pulse	2.0	Omnidirectional	U.FL	For FCC/IC and ETSI compliance

6 Environmental Specifications

6.1 Absolute maximum ratings

Table 12 Absolute Maximum Rating

Symbol	Description	Min	Max	Unit
T _{sop}	Specification temperature	-30	85	°C
T _{op} *	Operating temperature	-40	85	°C
T _{st}	Storage temperature	-40	85	°C
VDD_IO	IO Power supply	0	3.6	V
VDD_BAT	Power supply	0	5.0	V
RFin	RF input power		0	dBm
MSL	Moisture Sensitivity Level	3		
RoHS2	Restriction of Hazardous Substances	Compliant		

^{*}Note: RF performance may be degraded at extreme temperatures.

6.2 Recommended Operating Conditions

Table 13 Recommended Operating Conditions

	Min (V)	Typ (V)	Max (V)	Supply Current Spec (mA)
VDD_IO	2.40	3.30	3.60	10.00
VBAT	3.00	3.60	4.00	500.00

7 Packaging and Marking Information

7.1 Carrier Tape Dimensions

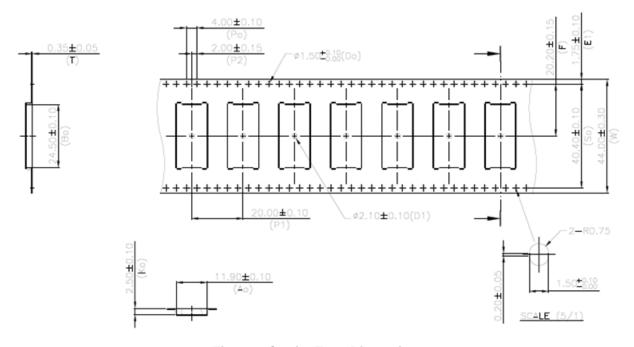
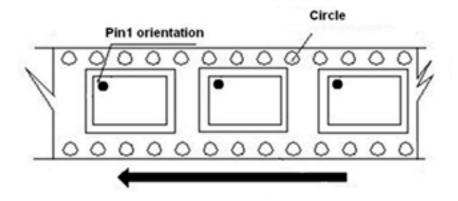


Figure 9 Carrier Tape Dimensions



Feeding Direction (Into Reel)

Double Sprocket Holes

Figure 10 SN8000 Pin1 Orientation

7.2 Module Marking Information

Module Marking for SN8000

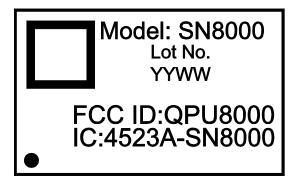




Figure 11 Module Marking Detail

8 Ordering Information

Table 14 Ordering Information

Product	RFM Model Number	RFM Part Number	Standard Order Increment
SN8000 Evaluation Development Kit	SN8000EVK	88-00153-85	1 pc
SN8000 Module in Tape & Reel	SN8000	88-00153-00	400 pcs/reel
SN8000UFL Evaluation Development Kit	SN8000UFL EVK	88-00153-87	1 pc
SN8000UFL Module in Tape & Reel	SN8000UFL	88-00153-02	400 pcs/reel

9 RoHS Declaration

To the best of our present knowledge, given our supplier declarations, this product does not contain substances that are banned by Directive 2011/65/EU or contain a maximum concentration of 0.1% by weight in homogeneous materials for

- Lead and lead compounds
- Mercury and mercury compounds
- Chromium (VI)
- PBB (polybrominated biphenyl)
- PBDE (polybrominated biphenyl ether)

And a maximum concentration of 0.01% by weight in homogeneous materials for

Cadmium and cadmium compounds

10 Regulatory Information

The table below shows the regulatory compliance status of the SN8000/8000UFL module.

Regulatory Body	Standard	Certificate ID
FCC	Part 15	QPU8000
IC	RSS-210	4523A-SN8000
ETSI	EN300 328, Ver. 1.8.1 ETSI EN301.489 - 17	Compliant
Anatel	Anatel Resolution NO. 506	1321-14-8488

For more information, see SN8000/SN8000UFL Wi-Fi Module User Manual [2].

11 Technical Support Contact

For technical support, please contact us at tech_sup@murata.com.

Murata Electronics N.A., Inc. 4100 Midway Road, Suite 2050 Carrollton, TX 75007 USA